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Data sheet acquired from Harris Semiconductor SCHS027C – Revised February 2004

CMOS Counter/Dividers

High-Voltage Types (20-Volt Rating) CD4017B—Decade Counter with

10 Decoded Outputs

CD4022B-Octal Counter with

8 Decoded Outputs

■ CD4017B and CD4022B are 5stage and 4-stage Johnson counters having 10 and 8 decoded outputs, respectively. Inputs include a CLOCK, a RESET, and a CLOCK INHIBIT signal. Schmitt trigger action in the CLOCK input circuit provides pulse shaping that allows unlimited clock input pulse rise and fall times.

These counters are advanced one count at the positive clock signal transition if the CLOCK INHIBIT signal is low. Counter advancement via the clock line is inhibited when the CLOCK INHIBIT signal is high. A high RESET signal clears the counter to its zero count. Use of the Johnson counter configuration permits high-speed operation, 2-input decode-gating and spike-free decoded outputs. Anti-lock gating is provided, thus assuring proper counting sequence. The decoded outputs are normally low and go high only at their respective decoded time slot. Each decoded output remains high for one full clock cycle. A CARRY-OUT signal completes one cycle every 10 clock input cycles in the CD4017B or every 8 clock input cycles in the CD4022B and is used to ripple-clock the succeeding device in a multi-device counting chain.

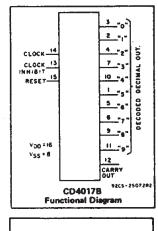
Features:

- Fully static operation
- Medium-speed operation . . .
- 10 MHz (typ.) at V_{DD} = 10 V
- Standardized, symmetrical output **characteristics**
- 100% tested for quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13A, "Standard Specifications for Description of 'B' Series CMOS Devices"

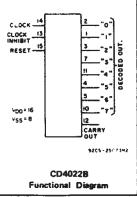
Applications:

- Decade counter/decimal decode display (CD4017B)
- Binary counter/decoder
- **Frequency division**
- Counter control/timers
- . **Divide-by-N counting**
- For further application information, see ICAN-6166 "COS/MOS MSI Counter and Register Design and **Applications**"

The CD4017B and CD4022B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic package (E suffix), 16-lead small-outline packages (NSR suffix), and 16-lead thin shrink small-outline packages (PW and PWR suffixes). The CD4017B types also are supplied in 16-lead small-outline packages (M and M96 suffixes).



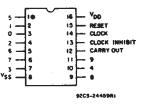
CD4017B, CD4022B Types

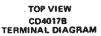


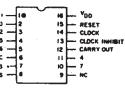
RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTICS	V _{DD}	LIN	UNITS	
	(V)	Min.	Max.	
Supply-Voltage Range (For T _A = Full Package- Temperature Range)		3	18	v
Clock Input Frequency, f _{CL}	5 10 15	1 1	2.5 5 5.5	MHz
Clock Pulse Width, t _W	5 10 15	200 90 60	+ 1 +	. ns
Clock Rise & Fall Time, t _{rCL} , t _{fCL}	5 10 15	UNLI	14.	
Clock Inhibit Setup Time, t _s	5 10 15	230 100 70	-	ns
Reset Pulse Width, t _{RW}	5 10 15	260 110 60		ns
Reset Removal Time, t _{rem}	5 10 15	400 280 150		ns



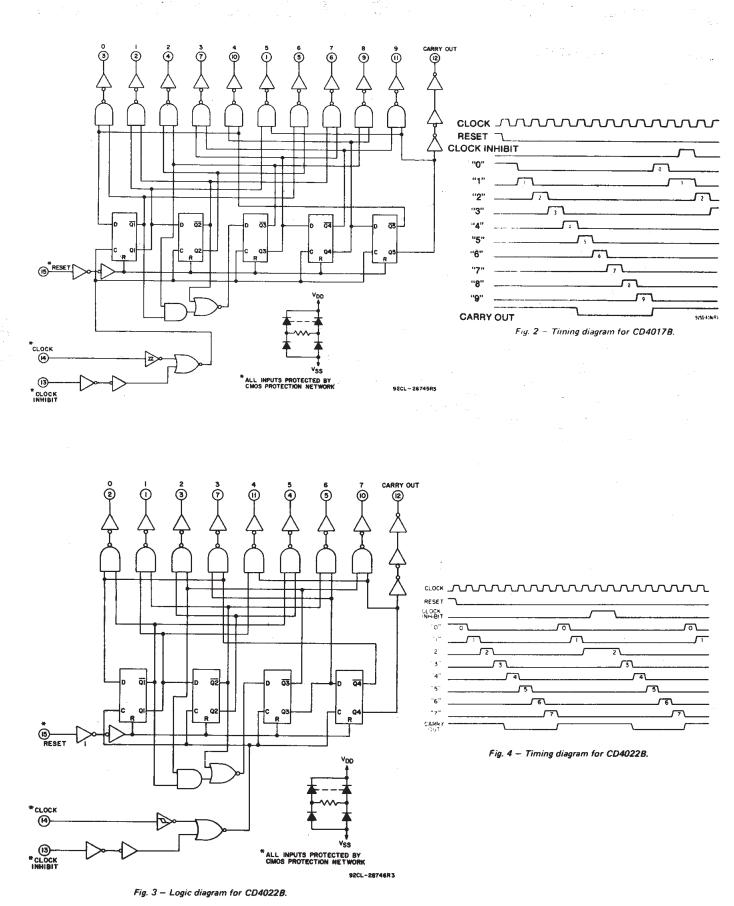




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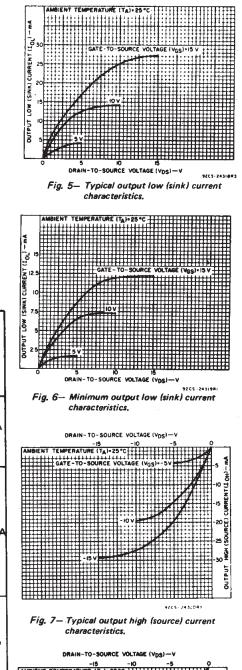
TOP VIEW NC - no connection CD4022B TERMINAL DIAGRAM

*Only if Pin 14 is used as the clock input. If Pin 13 is used as the clock input and Pin 14 is tied high (for advancing count on negative transition of the clock), rise and fall time should be \leq 15 μ s.



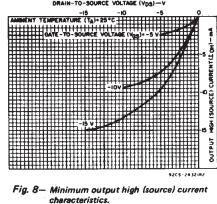
3-52

MAXIMUM RATINGS, Absolute-Maximum Values:	
DC SUPPLY-VOLTAGE RANGE, (VDD)	
Voltages referenced to V _{SS} Terminal)	0.5V to +20V
INPUT VOLTAGE RANGE, ALL INPUTS	0.5V to V _{DD} +0.5V
DC INPUT CURRENT, ANY ONE INPUT	±10mA
POWER DISSIPATION PER PACKAGE (PD):	
For T _A = -55°C to +100°C	
For TA = +100°C to +125°C De DEVICE DISSIPATION PER OUTPUT TRANSISTOR	
For T _A = +100°C to +125°C De	erate Linearity at 12mW/ ⁰ C to 200mW
For $T_A = +100^{\circ}C$ to $+125^{\circ}C$ De DEVICE DISSIPATION PER OUTPUT TRANSISTOR FOR $T_A =$ FULL PACKAGE-TEMPERATURE RANGE (All Package Ty OPERATING-TEMPERATURE RANGE (T_A)	prate Linearity at 12mW/°C to 200mW (pes)
For $T_A = +100^{\circ}C$ to $+125^{\circ}C$ De DEVICE DISSIPATION PER OUTPUT TRANSISTOR FOR $T_A =$ FULL PACKAGE-TEMPERATURE RANGE (All Package Ty OPERATING-TEMPERATURE RANGE (T_A)	prate Linearity at 12mW/°C to 200mW (pes)
For $T_A = +100^{\circ}C$ to $+125^{\circ}C$ De DEVICE DISSIPATION PER OUTPUT TRANSISTOR FOR $T_A = FULL$ PACKAGE-TEMPERATURE RANGE (All Package Ty	prate Linearity at 12mW/°C to 200mW (pes)



3

COMMERCIAL CMOS HIGH VOLTAGE IC8



STATIC	ELECTRICAL CHARACTERIS	TICS

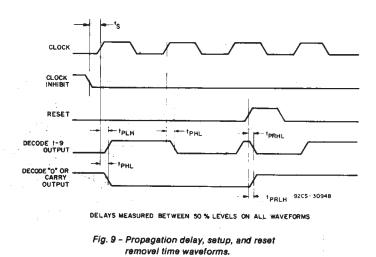
STATIC ELECT	RICAL (CHAR	ACTE	RISTIC	S						υ	
CHARAC- TERISTIC	CON	DITIO	NS	LIMITS AT INDICATED TEMPERATURES (°C)						c)	N I T	
	v _o	VO VIN					· · · · ·			S		
	(V)	(V)	V _{DD} (V)	-55	40	+85	+125	Min.	Тур.	Max.		
0	_	0,5	5	5	5	150	150	_	0.04	5		
Quiescent Device	-	0,10	10	10	10	300	300	-	0.04	10	μA	
Current,	-	0,15	15	20	20	600	600	_	0.04	20		
IDD Max.	_	0,20	20	100	100	3000	3000	-	0.08	100		
Output Low	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1	-		
(Sink) Current	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	-		
IOL Min.	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	-		
Queense High	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	-	mA	
Output High (Source)	2.5	0,5	5	2	-1.8	-1.3	-1.15	-1.6	-3.2			
Current, ^I OH ^{Min}	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	-		
	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	-		
Output Voltage:		0,5	5	0.05 – 0						0.05		
Low Level,		0,10	10	0.05 - 0 0.0								
VOL Max.	-	0,15	15	0.05 - 0 0.05						0.05	٧	
Output	~	0,5	5		4	.95	-	4.95	5	-		
Voltage: High-Level,		0,10	10	9.95 9.95 10 -								
VOH Min.	-	0,15	15		14	.95		14.95	15	· –		
	0.5,4.5 - 5 1.5					-	-	1.5				
Input Low Voltage	1,9	-	10	3 – –						3]	
VIL Max.	1.5,13.5	-	15	4						4	٧	
Input High	0.5,4.5	-	5	3.5 3.5 -				-				
Voltage,	1,9	-	10	7 7 –					-]		
V _{EH} Min.	1.5,13.5	-	15			11		11	-	-		
Input Current IIN Max.	-	0,18	18	±0.1 ±0.1 ±1 ±1 - ±1					±10 ⁻⁵	±0.1	μA	

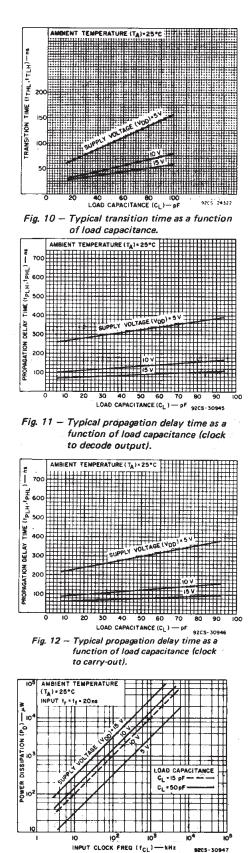
DYNAMIC ELECTRICAL CHARACTERISTICS

At T_A = 25°C, Input t_r, t_f = 20 ns, C_L = 50 pF, R_L = 200 k Ω

CHARACTERISTIC	CONDITIONS	LIMITS			UNITS
-	V _{DD} (V)	Min.	Тур.	Max.	
CLOCKED OPERATION			-	.	
	5	_	325	650	
Propagation Delay Time, tpHL, tpLH	10	-	135	270	
Decode Out	15	-	85	170	ns
	5	_	300	600	
Carry Out	10	. <u>-</u> .	125	250	
	15	_	80	160	
Transition Time, tTHL, tTLH	5	_	100	200	
Carry Out or Decode Out Line	10	_	50	100	ns
	15	-	40	80	
	5	2.5	5	-	
Maximum Clock Input Frequency, fCL*	10	5	10	_	MHz
	15	5.5	11	-	
	5	_	100	200	
Minimum Clock Pulse Width, tw	10	_	45	90	ns
-	15	-	30	60	
Clock Rise or Fall Time, t _r CL, t _f CL	5, 10, 15	UNLIMITED			
Minimum Clock Inhibit	5		115	230	
to Clock Setup Time, t _s	10	_	50	100	ns
	15	-	35	70	
Input Capacitance, CIN	Any Input	1	5	_	pF
RESET OPERATION	· · ·			÷	
Propagation Delay Time, tPHL, tPLH	5	_	265	530	
Carry Out or Decode Out Lines	10	_	115	230	ns
	15	-	85 [.]	170	
	5	_	130	260	
Minimum Reset Pulse Width, t _W	10	-	55	110	ns
	15	_	30	60	
	5		200	400	
Minimum Reset Removal Time	10	_		280	ns
	15	_	75	150	

* Measured with respect to carry output line.





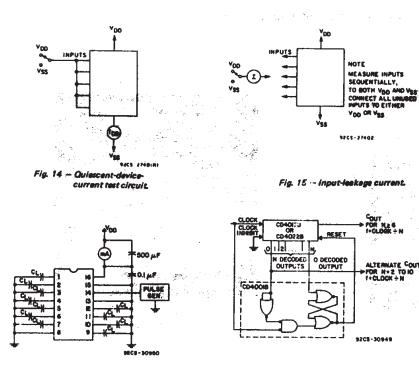
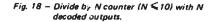


Fig. 17 - Dynamic power dissipation test circuit.



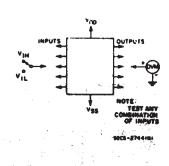


Fig. 16 - Input-voltage test circuit.

When the Nth decoded output is reached (Nth clock pulse) the S-R flip flop (constructed from two NOR gates of the CD4001B) generates a reset pulse which clears the CD4017B or CD4022B to its zero count. At this time, if the Nth dacoded output is greater than or equal to 6 in the CD-4017B or 5 in the CD4022B, the COUT line goes high to clock the next CD4017B or CD-4022B counter section. The "0" decoded output also goes high at this time. Coincidence of the clock low and decoded "0" output low resets the S-R flip flop to enable the CD4017B or CD4022B. If the Nth decoded output is less than 6 (CD4017B) or 5 (CD4022B), the COUT line will not go high and, therefore, cannot be used. in this case "0" decoded output may be used to perform the clocking function for the next counter.



3

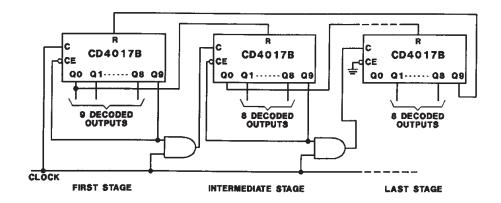
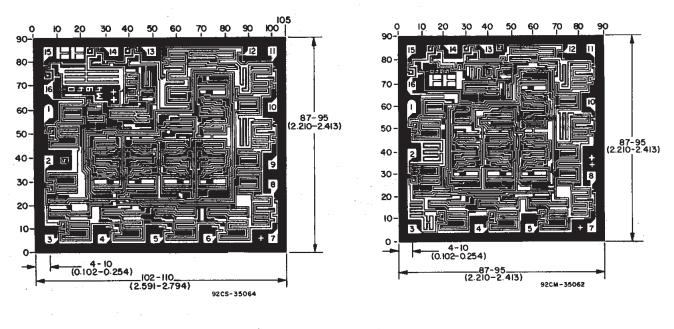


Fig. 19 - Cascading the CD4017B.

CHIP DIMENSIONS AND PAD LAYOUTS



CD4017BH

in Tae

CD4022BH

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils $(10^{-3}$ inch).

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17-Oct-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
89270AKB3T	OBSOLETE			0		TBD	Call TI	Call TI
CD4017BE	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4017BEE4	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4017BF	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
CD4017BF3A	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
CD4017BM	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4017BM96	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4017BM96E4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4017BME4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4017BNSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4017BNSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4017BPW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4017BPWE4	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4017BPWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4017BPWRE4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4022BE	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4022BEE4	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4022BF	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
CD4022BF3A	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
CD4022BNSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4022BNSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4022BPW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4022BPWE4	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4022BPWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4022BPWRE4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
JM38510/05651BEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.



LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect. NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in

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(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

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⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



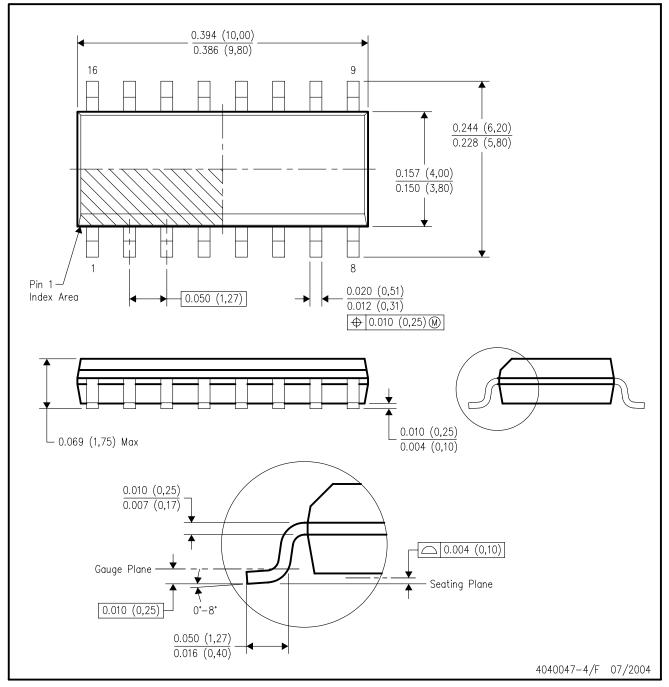
NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AC.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



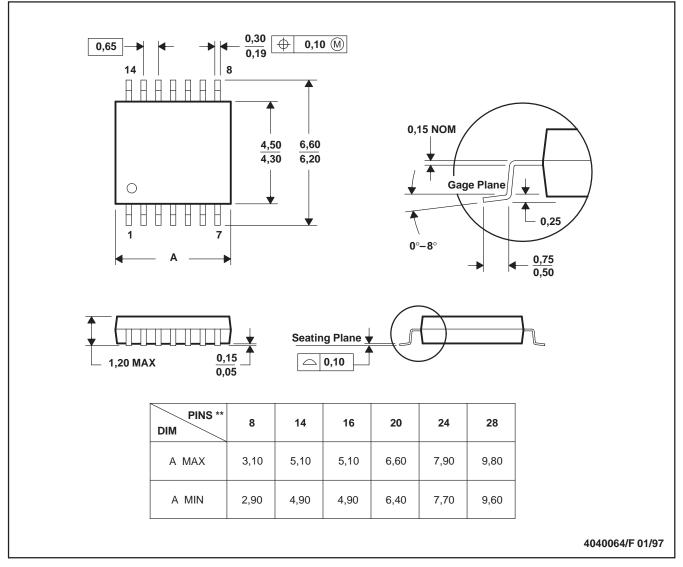
MECHANICAL DATA

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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